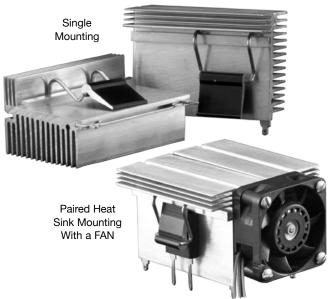
C40 Heat Sink System

For TO-247, TO-264 and SOT-227 Packages

The C40 Series Heat Sink System (Patent Pending) offers flexible, high performance and compact heat sinks with an exchangeable cam clip system for T0-247, T0-264 and S0T-227 (clip in development) devices. This powerful heat sink can be thru-hole soldered in single or paired configurations. The paired unit has mounting holes to accomodate a 40mm x 40mm fan. It is the ideal type of heat sink for high power density and small size (1U or 2U) electronic packaging with forced convection.



SERIES SPECIFICATIONS

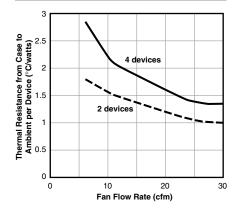
Heatsink	Surface Area	Weight	Length L
Part Number	(in² / mm²)	(oz / g)	(mm)
C40-058-VE C40-058-AE	63.8 / 41,180	2.5/71	58

consult factory for alternate lengths and clip combinations

CHARACTERISTICS

Heat Sink	Aluminum Alloy 6063-T5 or Equivalent with either degreased or black anodized finish.
Spring Clip	Music Wire, Per ASTM A228 with bright nickel plating
Solder Foot	Cold-rolled Steel, Per ASTM A-366 with pure tin over copper strike. RoHS compliant.
Fan	40mm fan with 4 self-tapping M3 screws
Interface Thermal Resistance	For improvement, use thermal joint compound, 0.005 Grafoil (TGon 800 by Laird), or phase change material (Hi-Flow by Bergquist) Insulator (Optional) Sil-Pad 900-S, K6 800-S and K10 by Bergquist

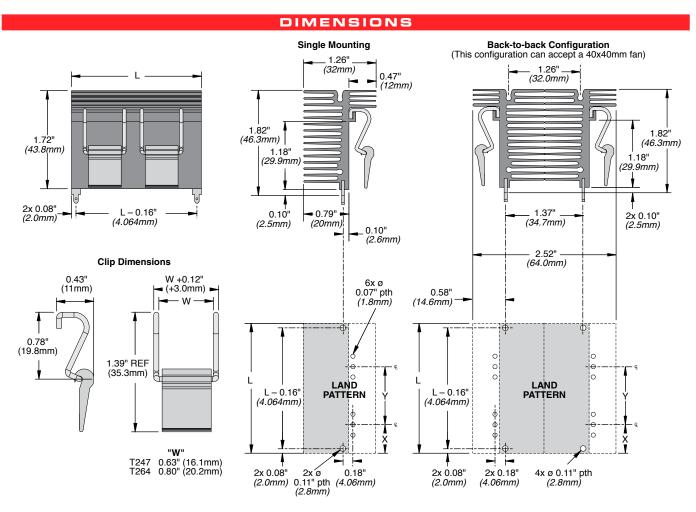
Heat Dissipation



(continued)

C40 Heat Sink System

For TO-247, TO-264 and SOT-227 Packages



NOTE: Due to possible screw torquing on long extrusions, Customer should check for coplanarity prior to final assembly or soldering.

HOW TO ORDER